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# **Identification cards** — Contactless integrated circuit cards — Proximity cards —

# Part 3: Initialization and anticollision

Cartes d'identification — Cartes à circuit intégré sans contact — Cartes de proximité —

Partie 3: Initialisation et anticollision



#### ISO/IEC 14443-3:2016(E)

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Co	ntent	S		Page
Fore	eword			v
Intr	oductio	n		vi
1	Scon	е		1
2	-		ferences	
3			efinitions	
4	Sym	bols and	abbreviated terms	3
5	Initial dialogs			
	5.1	Alterna	ating PICC and PCD support (PXD)	4
	5.2		ating between Type A and Type B commands	
		5.2.1	Polling	5
		5.2.2 5.2.3	Influence of Type A commands on PICC Type B operation	5
		5.2.3	Influence of Type B commands on PICC Type A operationTransition to POWER-OFF state	6
_	T	_		
6	Т <b>ур</b> е 6.1		tialization and anticollision	
	6.2		format and timing	
	0.2	6.2.1	Frame delay time	
		6.2.2	Request Guard Time	
		6.2.3	Frame formats	
		6.2.4	CRC_A	
	6.3		cates	
		6.3.1	POWER-OFF state	
		6.3.2	IDLE state	
		6.3.3 6.3.4	READY state ACTIVE state	
		6.3.5	HALT state	
		6.3.6	READY* state	
		6.3.7	ACTIVE* state	
		6.3.8	PROTOCOL state	
	6.4	Comma	and set	
		6.4.1	REQA and WUPA commands	
			ANTICOLLISION and SELECT commands	
	( F	6.4.3	HLTA command	
	6.5	6.5.1	sequenceSelect sequence flowchart	
		6.5.2	ATQA — Answer to Request	
		6.5.3	Anticollision and Select	
		6.5.4	UID contents and cascade levels	
7	Tyne	B — Init	tialization and anticollision	24
•	7.1		ter, frame format and timing	
		7.1.1	Character transmission format	
		7.1.2	Character separation	
		7.1.3	Frame format	
		7.1.4	SOF	
		7.1.5	EOF	
		7.1.6	Timing before the PICC SOF	
	7.2	7.1.7 CRC B	Timing before the PCD SOF	
	7.2		llision sequence	
	7.4		rates description	
		7.4.1	Initialization and anticollision flowchart	
		7.4.2	General statement for state description and transitions	

		7.4.3 POWER-OFF state	32	
		7.4.4 IDLE state		
		7.4.5 READY-REQUESTED sub-state		
		7.4.6 READY-DECLARED sub-state	32	
		7.4.7 PROTOCOL state	33	
		7.4.8 HALT state	33	
	7.5	Command set	33	
	7.6	Anticollision response rules	34	
		7.6.1 PICC with initialization only		
	7.7	REQB/WUPB command		
		7.7.1 REQB/WUPB command format		
		7.7.2 Coding of anticollision prefix byte APf	34	
		7.7.3 Coding of AFI		
		7.7.4 Coding of PARAM		
	7.8	Slot-MARKER command		
		7.8.1 Slot-MARKER command format		
		7.8.2 Coding of anticollision prefix byte APn		
	7.9	ATQB Response		
		7.9.1 ATQB response format		
		7.9.2 PUPI (Pseudo-Unique PICC Identifier)		
		7.9.3 Application data		
		7.9.4 Protocol Info		
	7.10	ATTRIB command		
		7.10.1 ATTRIB command format		
		7.10.2 Identifier		
		7.10.3 Coding of Param 1		
		7.10.4 Coding of Param 2		
		7.10.5 Coding of Param 3		
		7.10.6 Coding of Param 4		
	711	7.10.7 Higher layer INF		
	7.11	Answer to ATTRIB command		
	7.12	HLTB command and Answer		
8	Electromagnetic disturbance handling			
	8.1	General	47	
	8.2	EMD handling timing constraints		
	8.3	Recommendations for a PCD EMD handling algorithm	48	
Anne	<b>x A</b> (inf	Formative) Communication example Type A	49	
Anne	<b>x B</b> (inf	formative) CRC_A and CRC_B encoding.	51	
Anne	x C (inf	ormative) Type A timeslot — Initialization and anticollision	54	
Anne	<b>x D</b> (inf	formative) Example of Type B Anticollision Sequence	58	
		rmative) Bit rates of 3fc/4, fc, 3fc/2 and 2fc from PCD to PICC		
Bibliography				

### Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work. In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC | TC 1.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of document should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see <a href="https://www.iso.org/directives">www.iso.org/directives</a>).

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The committee responsible for this document is ISO/IEC JTC 1, *Information technology*, Subcommittee SC 17, *Identification cards and related devices*.

This third edition cancels and replaces the second edition (ISO/IEC 14443-3:2011), which has been technically revised. It also incorporates the Amendments ISO/IEC 14443-3:2011/Amd 1:2011, ISO/IEC 14443-3:2011/Amd 2:2012, ISO/IEC 14443-3:2011/Amd 3:2014 and ISO/IEC 14443-3:2011/Amd 6:2014.

ISO/IEC 14443 consists of the following parts, under the general title *Identification cards — Contactless integrated circuit cards — Proximity cards*:

- Part 1: Physical characteristics
- Part 2: Radio frequency power and signal interface
- Part 3: Initialization and anti-collision
- Part 4: Transmission protocol

This corrected version of ISO/IEC 14443-3:2016 incorporates the following correction.

Figure 4 was corrected: The last parity bit of a PICC standard frame with bit rate higher than fc/128 was changed from "odd" to "even".

#### ISO/IEC 14443-3:2016(E)

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### Introduction

ISO/IEC 14443 is one of a series of International Standards describing the parameters for identification cards as defined in ISO/IEC 7810 and the use of such cards for international interchange.

This part of ISO/IEC 14443 describes polling for proximity cards entering the field of a proximity coupling device, the byte format and framing, the initial Request and Answer to Request command content, methods to detect and communicate with one proximity card among several proximity cards (anticollision) and other parameters required to initialize communications between a proximity card and a proximity coupling device. Protocols and commands used by higher layers and by applications and which are used after the initial phase are described in ISO/IEC 14443-4.

ISO/IEC 14443 is intended to allow operation of proximity cards in the presence of other contactless cards conforming to ISO/IEC 10536 and ISO/IEC 15693.